

# MC100LVEL16

## 3.3V ECL Differential Receiver

### Description

The MC100LVEL16 is a differential receiver. The device is functionally equivalent to the EL16 device, operating from a 3.3 V supply. The LVEL16 exhibits a wider  $V_{IHCMR}$  range than its EL16 counterpart. With output transition times and propagation delays comparable to the EL16 the LVEL16 is ideally suited for interfacing with high frequency sources at 3.3 V supplies.

Under open input conditions, the Q input will be pulled down to  $V_{EE}$  and the  $\bar{Q}$  input will be biased to  $V_{CC}/2$ . This condition will force the Q output low.

The  $V_{BB}$  pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to  $V_{BB}$  as a switching reference voltage.  $V_{BB}$  may also rebias AC coupled inputs. When used, decouple  $V_{BB}$  and  $V_{CC}$  via a 0.01  $\mu\text{F}$  capacitor and limit current sourcing or sinking to 0.5 mA. When not used,  $V_{BB}$  should be left open.

### Features

- 300 ps Propagation Delay
- High Bandwidth Output Transitions
- The 100 Series Contains Temperature Compensation
- PECL Mode Operating Range:  $V_{CC} = 3.0\text{ V}$  to  $3.8\text{ V}$  with  $V_{EE} = 0\text{ V}$
- NECL Mode Operating Range:  $V_{CC} = 0\text{ V}$  with  $V_{EE} = -3.0\text{ V}$  to  $-3.8\text{ V}$
- Internal Input Pulldown Resistors on D, Pullup and Pulldown Resistors on  $\bar{D}$
- Q Output will Default LOW with Inputs Open or at  $V_{EE}$
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



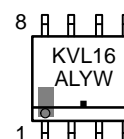
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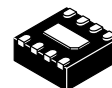
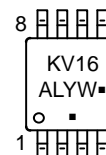
### MARKING DIAGRAMS\*



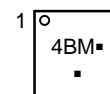
SOIC-8  
D SUFFIX  
CASE 751



TSSOP-8  
DT SUFFIX  
CASE 948R



DFN8  
MN SUFFIX  
CASE 506AA



A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week  
M = Date Code  
▪ = Pb-Free Package

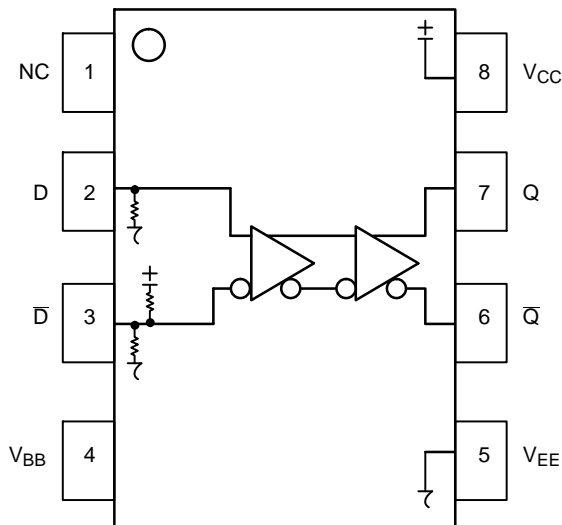
(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note AND8002/D.

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

# MC100LVEL16



**Table 1. PIN DESCRIPTION**

| PIN          | FUNCTION   |
|--------------|--|
| D, $\bar{D}$ | ECL Data Inputs  |
| Q, $\bar{Q}$ | ECL Data Outputs   |
| $V_{BB}$     | Reference Voltage Output   |
| $V_{CC}$     | Positive Supply  |
| $V_{EE}$     | Negative Supply  |
| NC           | No Connect   |
| EP           | (DFN8 only) Thermal exposed pad must be connected to a sufficient thermal conduit. Electrically connect to the most negative supply (GND) or leave unconnected, floating open. |

**Figure 1. Logic Diagram and Pinout Assignment**

**Table 2. ATTRIBUTES**

| Characteristics   | Value   |
|---|---|
| Internal Input Pulldown Resistor  | 75 k $\Omega$   |
| Internal Input Pullup Resistor  | 75 k $\Omega$   |
| ESD Protection  | Human Body Model > 4 kV<br>Machine Model > 400 V<br>Charged Device Model > 2 kV |
| Moisture Sensitivity, Indefinite Time out of Drypack, Pb-Free Packages (Note 1) | SOIC-8 Level 1<br>TSSOP-8 Level 3<br>DFN8 Level 1                               |
| Flammability Rating   | Oxygen Index: 28 to 34<br>UL 94 V-0 @ 0.125 in                                  |
| Transistor Count  | 79  |
| Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test                          |   |

1. Refer to Application Note AND8003/D for additional information.

# MC100LVEL16

**Table 3. MAXIMUM RATINGS**

| Symbol           | Parameter  | Condition 1                                    | Condition 2  | Rating            | Unit         |
|------------------|--|--|--|-------------------|--------------|
| V <sub>CC</sub>  | PECL Mode Power Supply                             | V <sub>EE</sub> = 0 V                          |  | 8 to 0            | V            |
| V <sub>EE</sub>  | NECL Mode Power Supply                             | V <sub>CC</sub> = 0 V                          |  | -8 to 0           | V            |
| V <sub>I</sub>   | PECL Mode Input Voltage<br>NECL Mode Input Voltage | V <sub>EE</sub> = 0 V<br>V <sub>CC</sub> = 0 V | V <sub>I</sub> ≤ V <sub>CC</sub><br>V <sub>I</sub> ≥ V <sub>EE</sub> | 6 to 0<br>-6 to 0 | V<br>V       |
| I <sub>out</sub> | Output Current                                     | Continuous<br>Surge                            |  | 50<br>100         | mA<br>mA     |
| I <sub>BB</sub>  | V <sub>BB</sub> Sink/Source                        |  |  | ± 0.5             | mA           |
| T <sub>A</sub>   | Operating Temperature Range                        |  |  | -40 to +85        | °C           |
| T <sub>stg</sub> | Storage Temperature Range                          |  |  | -65 to +150       | °C           |
| θ <sub>JA</sub>  | Thermal Resistance (Junction-to-Ambient)           | 0 LFPM<br>500 LFPM                             | SO-8<br>SO-8   | 190<br>130        | °C/W<br>°C/W |
| θ <sub>JC</sub>  | Thermal Resistance (Junction-to-Case)              | Standard Board                                 | SO-8   | 41 to 44 ± 5%     | °C/W         |
| θ <sub>JA</sub>  | Thermal Resistance (Junction-to-Ambient)           | 0 LFPM<br>500 LFPM                             | TSSOP-8<br>TSSOP-8   | 185<br>140        | °C/W<br>°C/W |
| θ <sub>JC</sub>  | Thermal Resistance (Junction-to-Case)              | Standard Board                                 | TSSOP-8  | 41 to 44 ± 5%     | °C/W         |
| θ <sub>JA</sub>  | Thermal Resistance (Junction-to-Ambient)           | 0 lfpm<br>500 lfpm                             | DFN8<br>DFN8   | 129<br>84         | °C/W<br>°C/W |
| T <sub>sol</sub> | Wave Solder<br>Pb<br>Pb-Free                       | <2 to 3 sec @ 248°C<br><2 to 3 sec @ 260°C     |  | 265<br>265        | °C           |
| θ <sub>JC</sub>  | Thermal Resistance (Junction-to-Case)              | (Note 2)                                       | DFN8   | 35 to 40          | °C/W         |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

2. JEDEC standard multilayer board – 2S2P (2 signal, 2 power)

# MC100LEVEL16

**Table 4. LVPECL DC CHARACTERISTICS**  $V_{CC} = 3.3\text{ V}$ ;  $V_{EE} = 0.0\text{ V}$  (Note 3)

| Symbol      | Characteristic  | -40°C     |      |      | 25°C |      |      | 85°C |      |      | Unit          |
|-------------|---|-----------|------|------|------|------|------|------|------|------|---------------|
|             |   | Min       | Typ  | Max  | Min  | Typ  | Max  | Min  | Typ  | Max  |               |
| $I_{EE}$    | Power Supply Current  |           | 17   | 23   |      | 17   | 23   |      | 18   | 24   | mA            |
| $V_{OH}$    | Output HIGH Voltage (Note 4)  | 2215      | 2295 | 2420 | 2275 | 2345 | 2420 | 2275 | 2345 | 2420 | mV            |
| $V_{OL}$    | Output LOW Voltage (Note 4)   | 1470      | 1605 | 1745 | 1490 | 1595 | 1680 | 1490 | 1595 | 1680 | mV            |
| $V_{IH}$    | Input HIGH Voltage (Single-Ended)   | 2135      |      | 2420 | 2135 |      | 2420 | 2135 |      | 2420 | mV            |
| $V_{IL}$    | Input LOW Voltage (Single-Ended)  | 1490      |      | 1825 | 1490 |      | 1825 | 1490 |      | 1825 | mV            |
| $V_{BB}$    | Output Voltage Reference  | 1.92      |      | 2.04 | 1.92 |      | 2.04 | 1.92 |      | 2.04 | V             |
| $V_{IHCMR}$ | Input HIGH Voltage Common Mode Range (Differential) (Note 5)<br>$V_{pp} < 500\text{ mV}$<br>$V_{pp} \geq 500\text{ mV}$ | 1.2       |      | 2.9  | 1.1  |      | 2.9  | 1.1  |      | 2.9  | V             |
|             |   | 1.5       |      | 2.9  | 1.4  |      | 2.9  | 1.4  |      | 2.9  | V             |
| $I_{IH}$    | Input HIGH Current  |           |      | 150  |      |      | 150  |      |      | 150  | $\mu\text{A}$ |
| $I_{IL}$    | Input LOW Current   | D         | 0.5  |      | 0.5  |      |      | 0.5  |      |      | $\mu\text{A}$ |
|             |   | $\bar{D}$ | -600 |      | -600 |      |      | -600 |      |      | $\mu\text{A}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary  $\pm 0.3\text{ V}$ .

4. Outputs are terminated through a  $50\ \Omega$  resistor to  $V_{CC} - 2\text{ V}$ .

5.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ , max varies 1:1 with  $V_{CC}$ . The  $V_{IHCMR}$  range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between  $V_{ppmin}$  and  $1\text{ V}$ .

**Table 5. LVNECL DC CHARACTERISTICS**  $V_{CC} = 0.0\text{ V}$ ;  $V_{EE} = -3.3\text{ V}$  (Note 6)

| Symbol      | Characteristic  | -40°C     |       |       | 25°C  |       |       | 85°C  |       |       | Unit          |
|-------------|---|-----------|-------|-------|-------|-------|-------|-------|-------|-------|---------------|
|             |   | Min       | Typ   | Max   | Min   | Typ   | Max   | Min   | Typ   | Max   |               |
| $I_{EE}$    | Power Supply Current  |           | 17    | 23    |       | 17    | 23    |       | 18    | 24    | mA            |
| $V_{OH}$    | Output HIGH Voltage (Note 7)  | -1085     | -1005 | -880  | -1025 | -955  | -880  | -1025 | -955  | -880  | mV            |
| $V_{OL}$    | Output LOW Voltage (Note 7)   | -1830     | -1695 | -1555 | -1810 | -1705 | -1620 | -1810 | -1705 | -1620 | mV            |
| $V_{IH}$    | Input HIGH Voltage (Single-Ended)   | -1165     |       | -880  | -1165 |       | -880  | -1165 |       | -880  | mV            |
| $V_{IL}$    | Input LOW Voltage (Single-Ended)  | -1810     |       | -1475 | -1810 |       | -1475 | -1810 |       | -1475 | mV            |
| $V_{BB}$    | Output Voltage Reference  | -1.38     |       | -1.26 | -1.38 |       | -1.26 | -1.38 |       | -1.26 | V             |
| $V_{IHCMR}$ | Input HIGH Voltage Common Mode Range (Differential) (Note 8)<br>$V_{pp} < 500\text{ mV}$<br>$V_{pp} \geq 500\text{ mV}$ | -2.1      |       | -0.4  | -2.2  |       | -0.4  | -2.2  |       | -0.4  | V             |
|             |   | -1.8      |       | -0.4  | -1.9  |       | -0.4  | -1.9  |       | -0.4  | V             |
| $I_{IH}$    | Input HIGH Current  |           |       | 150   |       |       | 150   |       |       | 150   | $\mu\text{A}$ |
| $I_{IL}$    | Input LOW Current   | D         | 0.5   |       | 0.5   |       |       | 0.5   |       |       | $\mu\text{A}$ |
|             |   | $\bar{D}$ | -600  |       | -600  |       |       | -600  |       |       | $\mu\text{A}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6. Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary  $\pm 0.3\text{ V}$ .

7. Outputs are terminated through a  $50\ \Omega$  resistor to  $V_{CC} - 2\text{ V}$ .

8.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ , max varies 1:1 with  $V_{CC}$ . The  $V_{IHCMR}$  range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between  $V_{ppmin}$  and  $1\text{ V}$ .

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**Table 6. AC CHARACTERISTICS**  $V_{CC}= 3.3\text{ V}$ ;  $V_{EE}= 0.0\text{ V}$  or  $V_{CC}= 0.0\text{ V}$ ;  $V_{EE}= -3.3\text{ V}$  (Note 9)

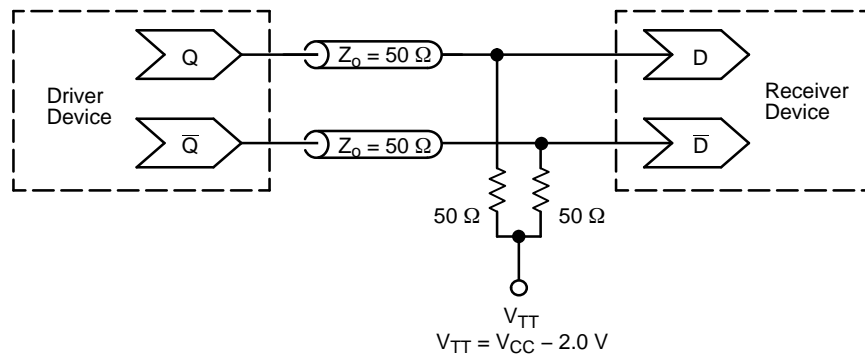
| Symbol                               | Characteristic  | -40°C      |            |            | 25°C       |            |            | 85°C       |            |            | Unit |
|--------------------------------------|---|------------|------------|------------|------------|------------|------------|------------|------------|------------|------|
|                                      |   | Min        | Typ        | Max        | Min        | Typ        | Max        | Min        | Typ        | Max        |      |
| $f_{\max}$                           | Maximum Toggle Frequency                                    |            | 1.75       |            |            | 1.75       |            |            | 1.75       |            | GHz  |
| $t_{\text{PLH}}$<br>$t_{\text{PHL}}$ | Propagation Delay to Output<br>Differential<br>Single-Ended | 150<br>100 | 275<br>275 | 400<br>450 | 225<br>175 | 300<br>300 | 375<br>425 | 240<br>190 | 315<br>315 | 390<br>440 | ps   |
| $t_{\text{SKEW}}$                    | Duty Cycle Skew (Differential) (Note 10)                    |            | 5          | 30         |            | 5          | 20         |            | 5          | 20         | ps   |
| $t_{\text{JITTER}}$                  | Random Clock Jitter (RMS)                                   |            | 0.7        |            |            | 0.7        |            |            | 0.7        |            | ps   |
| $V_{\text{PP}}$                      | Input Swing (Note 11)                                       | 150        |            | 1000       | 150        |            | 1000       | 150        |            | 1000       | mV   |
| $t_r$<br>$t_f$                       | Output Rise/Fall Times Q<br>(20% – 80%)                     | 120        | 220        | 320        | 120        | 220        | 320        | 120        | 220        | 320        | ps   |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

9.  $V_{EE}$  can vary  $\pm 0.3\text{ V}$ .

10. Duty cycle skew is the difference between a  $t_{\text{PLH}}$  and  $t_{\text{PHL}}$  propagation delay through a device.

11.  $V_{\text{PP}(\text{min})}$  is minimum input swing for which AC parameters guaranteed. The device has a DC gain of  $\approx 40$ .



**Figure 2. Typical Termination for Output Driver and Device Evaluation**  
(See Application Note AND8020/D – Termination of ECL Logic Devices.)

# MC100LEVEL16

## ORDERING INFORMATION

| Device            | Package              | Shipping†          |
|-------------------|----------------------|--------------------|
| MC100LEVEL16DG    | SO-8<br>(Pb-Free)    | 98 Units / Rail    |
| MC100LEVEL16DR2G  | SO-8<br>(Pb-Free)    | 2500 Tape & Reel   |
| MC100LEVEL16DTG   | TSSOP-8<br>(Pb-Free) | 100 Units / Rail   |
| MC100LEVEL16DTR2G | TSSOP-8<br>(Pb-Free) | 2500 Tape & Reel   |
| MC100LEVEL16MNR4G | DFN8<br>(Pb-Free)    | 1000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

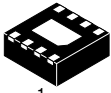
### Resource Reference of Application Notes

- AN1405/D** – ECL Clock Distribution Techniques
- AN1406/D** – Designing with PECL (ECL at +5.0 V)
- AN1503/D** – ECLinPS™ I/O SPiCE Modeling Kit
- AN1504/D** – Metastability and the ECLinPS Family
- AN1568/D** – Interfacing Between LVDS and ECL
- AN1672/D** – The ECL Translator Guide
- AND8001/D** – Odd Number Counters Design
- AND8002/D** – Marking and Date Codes
- AND8020/D** – Termination of ECL Logic Devices
- AND8066/D** – Interfacing with ECLinPS
- AND8090/D** – AC Characteristics of ECL Devices

# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS

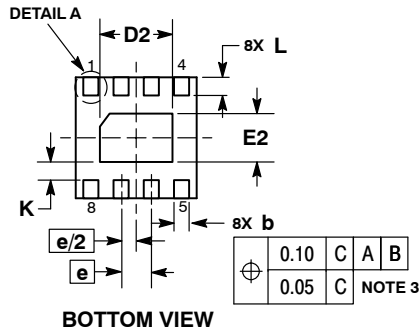
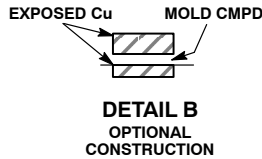
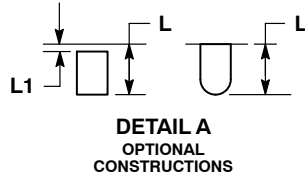
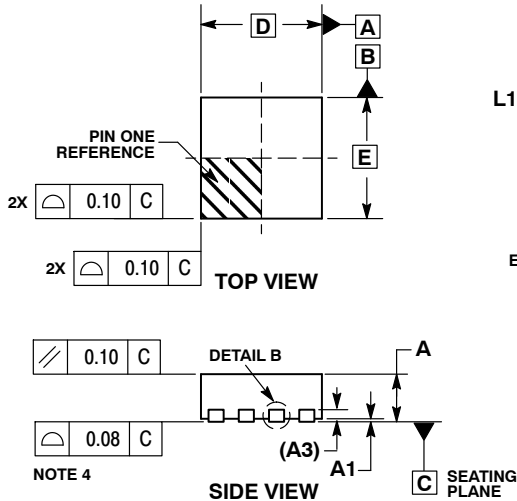
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SCALE 4:1

DFN8 2x2, 0.5P  
CASE 506AA-01  
ISSUE E

DATE 22 JAN 2010

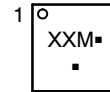


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| MILLIMETERS |      |      |
|-------------|------|------|
| DIM         | MIN  | MAX  |
| A           | 0.80 | 1.00 |
| A1          | 0.00 | 0.05 |
| A3          | 0.20 | REF  |
| b           | 0.20 | 0.30 |
| D           | 2.00 | BSC  |
| D2          | 1.10 | 1.30 |
| E           | 2.00 | BSC  |
| E2          | 0.70 | 0.90 |
| e           | 0.50 | BSC  |
| K           | 0.30 | REF  |
| L           | 0.25 | 0.35 |
| L1          | ---  | 0.10 |

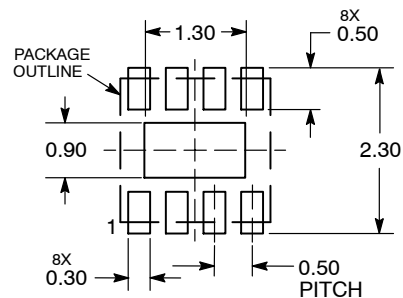
**GENERIC MARKING DIAGRAM\***



- XX = Specific Device Code
- M = Date Code
- = Pb-Free Device

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present.

**RECOMMENDED SOLDERING FOOTPRINT\***



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

|                         |                                   |  |
|-------------------------|-----------------------------------|--|
| <b>DOCUMENT NUMBER:</b> | <b>98AON18658D</b>                | Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |
| <b>DESCRIPTION:</b>     | <b>DFN8, 2.0X2.0, 0.5MM PITCH</b> | <b>PAGE 1 OF 1</b>   |

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# MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

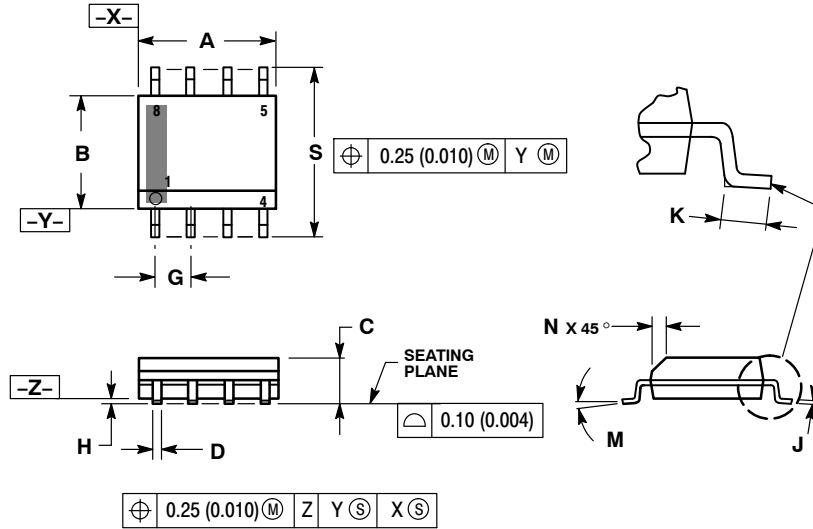
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SCALE 1:1

SOIC-8 NB  
CASE 751-07  
ISSUE AK

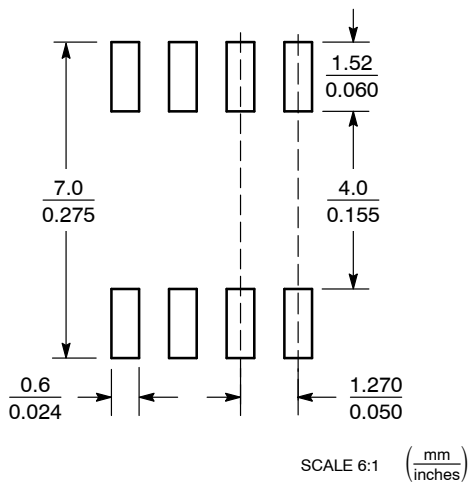
DATE 16 FEB 2011



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
  5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
  6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

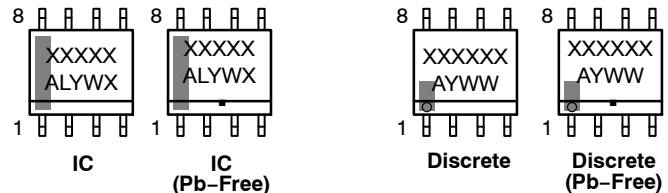
| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 4.80        | 5.00 | 0.189     | 0.197 |
| B   | 3.80        | 4.00 | 0.150     | 0.157 |
| C   | 1.35        | 1.75 | 0.053     | 0.069 |
| D   | 0.33        | 0.51 | 0.013     | 0.020 |
| G   | 1.27 BSC    |      | 0.050 BSC |       |
| H   | 0.10        | 0.25 | 0.004     | 0.010 |
| J   | 0.19        | 0.25 | 0.007     | 0.010 |
| K   | 0.40        | 1.27 | 0.016     | 0.050 |
| M   | 0°          | 8°   | 0°        | 8°    |
| N   | 0.25        | 0.50 | 0.010     | 0.020 |
| S   | 5.80        | 6.20 | 0.228     | 0.244 |

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### GENERIC MARKING DIAGRAM\*



XXXXXX = Specific Device Code  
 A = Assembly Location  
 L = Wafer Lot  
 Y = Year  
 W = Work Week  
 ■ = Pb-Free Package

XXXXXX = Specific Device Code  
 A = Assembly Location  
 Y = Year  
 WW = Work Week  
 ■ = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

|                  |             |  |
|------------------|-------------|--|
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| DESCRIPTION:     | SOIC-8 NB   | PAGE 1 OF 2  |

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**SOIC-8 NB**  
**CASE 751-07**  
**ISSUE AK**

DATE 16 FEB 2011

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|--|---|---|---|
| <p><b>STYLE 1:</b><br/> PIN 1. EMITTER<br/> 2. COLLECTOR<br/> 3. COLLECTOR<br/> 4. EMITTER<br/> 5. EMITTER<br/> 6. BASE<br/> 7. BASE<br/> 8. EMITTER</p>   | <p><b>STYLE 2:</b><br/> PIN 1. COLLECTOR, DIE, #1<br/> 2. COLLECTOR, #1<br/> 3. COLLECTOR, #2<br/> 4. COLLECTOR, #2<br/> 5. BASE, #2<br/> 6. EMITTER, #2<br/> 7. BASE, #1<br/> 8. EMITTER, #1</p>               | <p><b>STYLE 3:</b><br/> PIN 1. DRAIN, DIE #1<br/> 2. DRAIN, #1<br/> 3. DRAIN, #2<br/> 4. DRAIN, #2<br/> 5. GATE, #2<br/> 6. SOURCE, #2<br/> 7. GATE, #1<br/> 8. SOURCE, #1</p>                            | <p><b>STYLE 4:</b><br/> PIN 1. ANODE<br/> 2. ANODE<br/> 3. ANODE<br/> 4. ANODE<br/> 5. ANODE<br/> 6. ANODE<br/> 7. ANODE<br/> 8. COMMON CATHODE</p>   |
| <p><b>STYLE 5:</b><br/> PIN 1. DRAIN<br/> 2. DRAIN<br/> 3. DRAIN<br/> 4. DRAIN<br/> 5. GATE<br/> 6. GATE<br/> 7. SOURCE<br/> 8. SOURCE</p>   | <p><b>STYLE 6:</b><br/> PIN 1. SOURCE<br/> 2. DRAIN<br/> 3. DRAIN<br/> 4. SOURCE<br/> 5. SOURCE<br/> 6. GATE<br/> 7. GATE<br/> 8. SOURCE</p>  | <p><b>STYLE 7:</b><br/> PIN 1. INPUT<br/> 2. EXTERNAL BYPASS<br/> 3. THIRD STAGE SOURCE<br/> 4. GROUND<br/> 5. DRAIN<br/> 6. GATE 3<br/> 7. SECOND STAGE Vd<br/> 8. FIRST STAGE Vd</p>                    | <p><b>STYLE 8:</b><br/> PIN 1. COLLECTOR, DIE #1<br/> 2. BASE, #1<br/> 3. BASE, #2<br/> 4. COLLECTOR, #2<br/> 5. COLLECTOR, #2<br/> 6. EMITTER, #2<br/> 7. EMITTER, #1<br/> 8. COLLECTOR, #1</p>                              |
| <p><b>STYLE 9:</b><br/> PIN 1. EMITTER, COMMON<br/> 2. COLLECTOR, DIE #1<br/> 3. COLLECTOR, DIE #2<br/> 4. EMITTER, COMMON<br/> 5. EMITTER, COMMON<br/> 6. BASE, DIE #2<br/> 7. BASE, DIE #1<br/> 8. EMITTER, COMMON</p> | <p><b>STYLE 10:</b><br/> PIN 1. GROUND<br/> 2. BIAS 1<br/> 3. OUTPUT<br/> 4. GROUND<br/> 5. GROUND<br/> 6. BIAS 2<br/> 7. INPUT<br/> 8. GROUND</p>  | <p><b>STYLE 11:</b><br/> PIN 1. SOURCE 1<br/> 2. GATE 1<br/> 3. SOURCE 2<br/> 4. GATE 2<br/> 5. DRAIN 2<br/> 6. DRAIN 2<br/> 7. DRAIN 1<br/> 8. DRAIN 1</p>   | <p><b>STYLE 12:</b><br/> PIN 1. SOURCE<br/> 2. SOURCE<br/> 3. SOURCE<br/> 4. GATE<br/> 5. DRAIN<br/> 6. DRAIN<br/> 7. DRAIN<br/> 8. DRAIN</p>   |
| <p><b>STYLE 13:</b><br/> PIN 1. N.C.<br/> 2. SOURCE<br/> 3. SOURCE<br/> 4. GATE<br/> 5. DRAIN<br/> 6. DRAIN<br/> 7. DRAIN<br/> 8. DRAIN</p>  | <p><b>STYLE 14:</b><br/> PIN 1. N-SOURCE<br/> 2. N-GATE<br/> 3. P-SOURCE<br/> 4. P-GATE<br/> 5. P-DRAIN<br/> 6. P-DRAIN<br/> 7. N-DRAIN<br/> 8. N-DRAIN</p>   | <p><b>STYLE 15:</b><br/> PIN 1. ANODE 1<br/> 2. ANODE 1<br/> 3. ANODE 1<br/> 4. ANODE 1<br/> 5. CATHODE, COMMON<br/> 6. CATHODE, COMMON<br/> 7. CATHODE, COMMON<br/> 8. CATHODE, COMMON</p>               | <p><b>STYLE 16:</b><br/> PIN 1. EMITTER, DIE #1<br/> 2. BASE, DIE #1<br/> 3. EMITTER, DIE #2<br/> 4. BASE, DIE #2<br/> 5. COLLECTOR, DIE #2<br/> 6. COLLECTOR, DIE #2<br/> 7. COLLECTOR, DIE #1<br/> 8. COLLECTOR, DIE #1</p> |
| <p><b>STYLE 17:</b><br/> PIN 1. VCC<br/> 2. V2OUT<br/> 3. V1OUT<br/> 4. TXE<br/> 5. RXE<br/> 6. VEE<br/> 7. GND<br/> 8. ACC</p>  | <p><b>STYLE 18:</b><br/> PIN 1. ANODE<br/> 2. ANODE<br/> 3. SOURCE<br/> 4. GATE<br/> 5. DRAIN<br/> 6. DRAIN<br/> 7. CATHODE<br/> 8. CATHODE</p>   | <p><b>STYLE 19:</b><br/> PIN 1. SOURCE 1<br/> 2. GATE 1<br/> 3. SOURCE 2<br/> 4. GATE 2<br/> 5. DRAIN 2<br/> 6. MIRROR 2<br/> 7. DRAIN 1<br/> 8. MIRROR 1</p>   | <p><b>STYLE 20:</b><br/> PIN 1. SOURCE (N)<br/> 2. GATE (N)<br/> 3. SOURCE (P)<br/> 4. GATE (P)<br/> 5. DRAIN<br/> 6. DRAIN<br/> 7. DRAIN<br/> 8. DRAIN</p>   |
| <p><b>STYLE 21:</b><br/> PIN 1. CATHODE 1<br/> 2. CATHODE 2<br/> 3. CATHODE 3<br/> 4. CATHODE 4<br/> 5. CATHODE 5<br/> 6. COMMON ANODE<br/> 7. COMMON ANODE<br/> 8. CATHODE 6</p>  | <p><b>STYLE 22:</b><br/> PIN 1. I/O LINE 1<br/> 2. COMMON CATHODE/VCC<br/> 3. COMMON CATHODE/VCC<br/> 4. I/O LINE 3<br/> 5. COMMON ANODE/GND<br/> 6. I/O LINE 4<br/> 7. I/O LINE 5<br/> 8. COMMON ANODE/GND</p> | <p><b>STYLE 23:</b><br/> PIN 1. LINE 1 IN<br/> 2. COMMON ANODE/GND<br/> 3. COMMON ANODE/GND<br/> 4. LINE 2 IN<br/> 5. LINE 2 OUT<br/> 6. COMMON ANODE/GND<br/> 7. COMMON ANODE/GND<br/> 8. LINE 1 OUT</p> | <p><b>STYLE 24:</b><br/> PIN 1. BASE<br/> 2. EMITTER<br/> 3. COLLECTOR/ANODE<br/> 4. COLLECTOR/ANODE<br/> 5. CATHODE<br/> 6. CATHODE<br/> 7. COLLECTOR/ANODE<br/> 8. COLLECTOR/ANODE</p>                                      |
| <p><b>STYLE 25:</b><br/> PIN 1. VIN<br/> 2. N/C<br/> 3. REXT<br/> 4. GND<br/> 5. IOUT<br/> 6. IOUT<br/> 7. IOUT<br/> 8. IOUT</p>   | <p><b>STYLE 26:</b><br/> PIN 1. GND<br/> 2. dv/dt<br/> 3. ENABLE<br/> 4. ILIMIT<br/> 5. SOURCE<br/> 6. SOURCE<br/> 7. SOURCE<br/> 8. VCC</p>  | <p><b>STYLE 27:</b><br/> PIN 1. ILIMIT<br/> 2. OVLO<br/> 3. UVLO<br/> 4. INPUT+<br/> 5. SOURCE<br/> 6. SOURCE<br/> 7. SOURCE<br/> 8. DRAIN</p>  | <p><b>STYLE 28:</b><br/> PIN 1. SW_TO_GND<br/> 2. DASIC OFF<br/> 3. DASIC_SW_DET<br/> 4. GND<br/> 5. V_MON<br/> 6. VBULK<br/> 7. VBULK<br/> 8. VIN</p>  |
| <p><b>STYLE 29:</b><br/> PIN 1. BASE, DIE #1<br/> 2. EMITTER, #1<br/> 3. BASE, #2<br/> 4. EMITTER, #2<br/> 5. COLLECTOR, #2<br/> 6. COLLECTOR, #2<br/> 7. COLLECTOR, #1<br/> 8. COLLECTOR, #1</p>                        | <p><b>STYLE 30:</b><br/> PIN 1. DRAIN 1<br/> 2. DRAIN 1<br/> 3. GATE 2<br/> 4. SOURCE 2<br/> 5. SOURCE 1/DRAIN 2<br/> 6. SOURCE 1/DRAIN 2<br/> 7. SOURCE 1/DRAIN 2<br/> 8. GATE 1</p>                           |   |   |

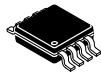
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# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS

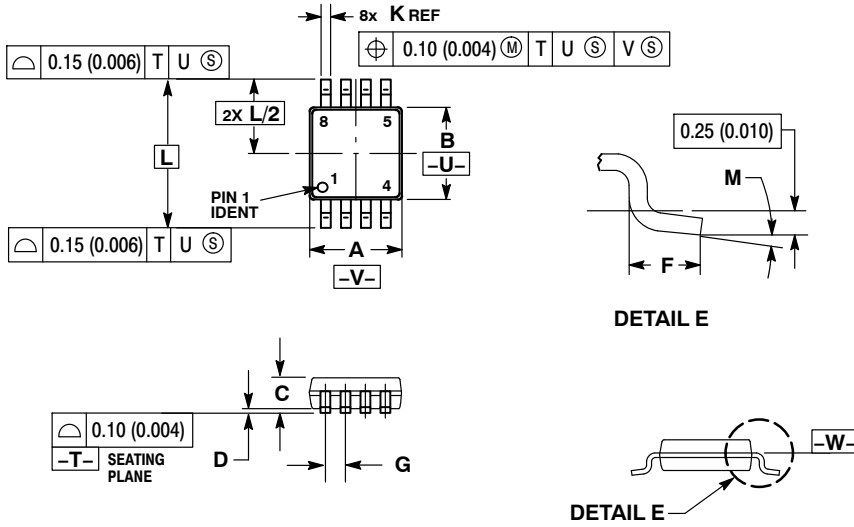
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SCALE 2:1

### TSSOP 8 CASE 948R-02 ISSUE A

DATE 04/07/2000



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 2.90        | 3.10 | 0.114     | 0.122 |
| B   | 2.90        | 3.10 | 0.114     | 0.122 |
| C   | 0.80        | 1.10 | 0.031     | 0.043 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.40        | 0.70 | 0.016     | 0.028 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| K   | 0.25        | 0.40 | 0.010     | 0.016 |
| L   | 4.90 BSC    |      | 0.193 BSC |       |
| M   | 0°          | 6°   | 0°        | 6°    |

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